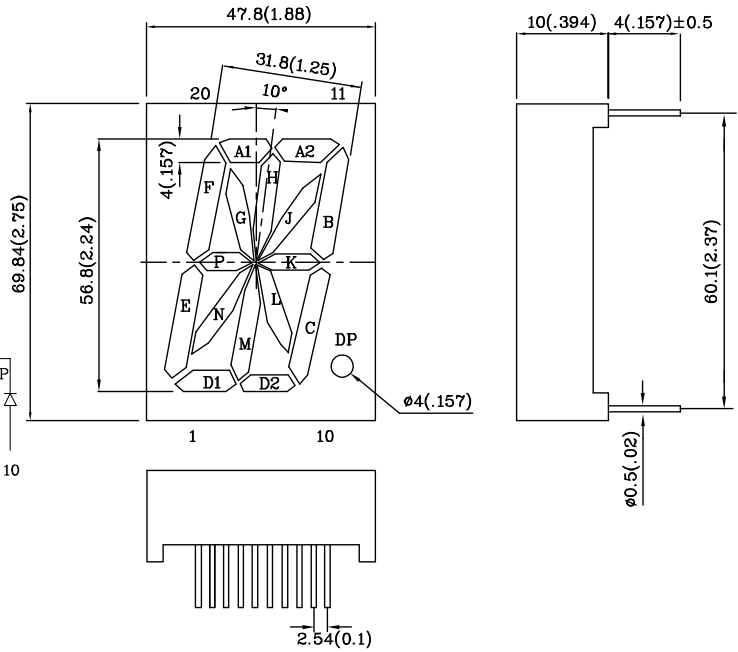
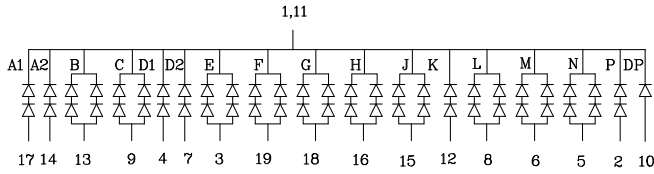


Features

- 2.3 INCH CHARACTER HEIGHT.
- LOW CURRENT OPERATION.
- HIGH CONTRAST AND LIGHT OUTPUT.
- EASY MOUNTING ON P.C. BOARDS OR SOCKETS.
- MECHANICALLY RUGGED.
- STANDARD: GRAY FACE, WHITE SEGMENT.
- RoHS COMPLIANT.



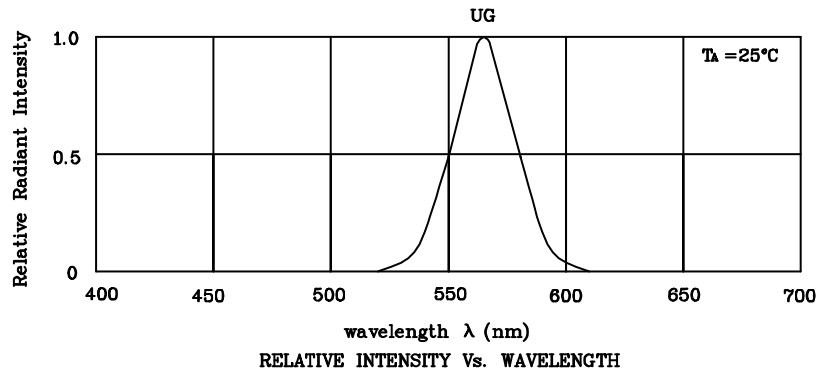
Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25(0.01)$ " unless otherwise noted.

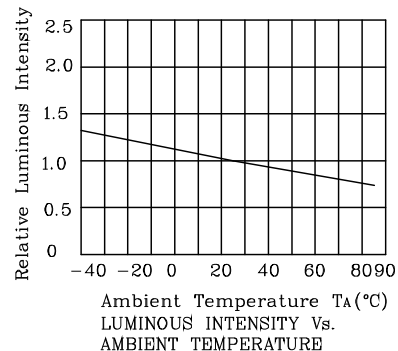
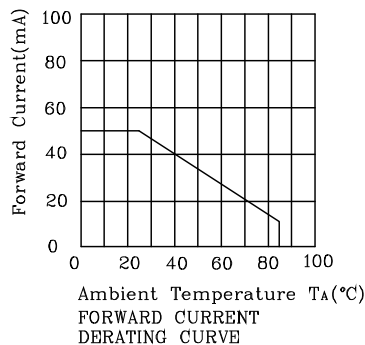
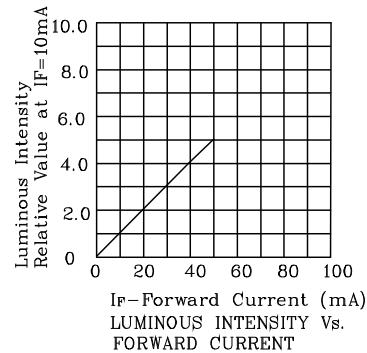
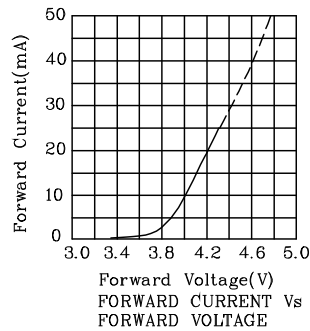
Absolute maximum ratings (TA=25°C)			UG (GaP)	Unit
Reverse Voltage	A1,A2,D1, D2,P,K	VR	10	V
	B,C,E,F,G, H,J,L,M,N		10	
	DP		5	
Forward Current	A1,A2,D1, D2,P,K	IF	25	mA
	B,C,E,F,G, H,J,L,M,N		50	
	DP		25	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	A1,A2,D1, D2,P,K	iFS	140	mA
	B,C,E,F,G, H,J,L,M,N		280	
	DP		140	
Power Dissipation	A1,A2,D1, D2,P,K	PT	125	mW
	B,C,E,F,G, H,J,L,M,N		250	
	DP		105	
Operating Temperature		TA	-40 ~ +85	°C
Storage Temperature		Tstg	-40 ~ +85	
Lead Solder Temperature [2mm Below Package Base]		260°C For 5 Seconds		

Operating Characteristics (TA=25°C)				UG (GaP)	Unit
Forward Voltage (Typ.) (IF=10mA)	A1,A2,D1,D2, P,K	VF	4.0	V	
	B,C,E,F,G,H, J,L,M,N		2.0		
	DP		2.0		
Forward Voltage (Max.) (IF=10mA)	A1,A2,D1,D2, P,K	VF	5.0	V	
	B,C,E,F,G,H, J,L,M,N		2.5		
	DP		2.5		
Reverse Current (VR=10V)	A1,A2,D1,D2, P,K	IR	10	uA	
Reverse Current (VR=10V)	B,C,E,F,G,H, J,L,M,N		20		
Reverse Current (VR=5V)	DP		10		
Wavelength of Peak Emission (IF=10mA)		λ P	565	nm	
Wavelength of Dominant Emission (IF=10mA)		λ D	568	nm	
Spectral Line Full Width At Half- Maximum (IF=10mA)		Δλ	30	nm	
Capacitance (VF=0V, f=1MHz)		C	15	pF	

Part Number	Emitting Color	Emitting Material	Luminous Intensity (IF=10mA) ucd		Wavelength nm λ P	Description
			min.	typ.		
XAUG60C	Green	GaP	1900	10490	565	Common Cathode, Rt. Hand Decimal



❖ **UG**



Remarks:

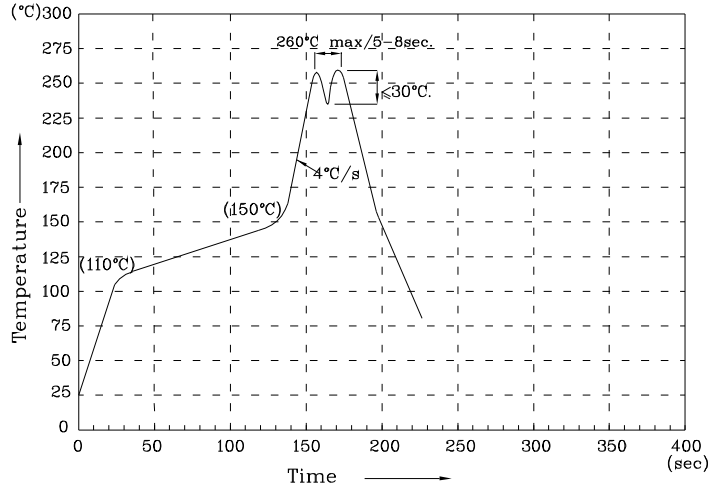
If special sorting is required (e.g. binning based on forward voltage, luminous intensity or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous Intensity: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

XAUG60C

Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

1. Recommend the wave temperature 245°C~260°C. The maximum soldering temperature should be less than 260°C.
2. Do not apply stress on epoxy resins when temperature is over 85 degree°C.
3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
4. No more than once.